

600V, 30A, Trench FS II Fast IGBT

General Description:

Using NCE's proprietary trench design and advanced FS (Field Stop) second generation technology, the 600V Trench FS II IGBT offers superior conduction and switching performances, and easy parallel operation;

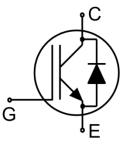
Features

Trench FSII Technology offering

- Very low V_{CE} (sat)
- High speed switching
- Positive temperature coefficient in V_{CE} (sat)
- Very tight parameter distribution
- High ruggedness, temperature stable behavior

Application

- Air Condition
- Inverters
- Motor drives



Schematic diagram

Package Marking and Ordering Information

Device	Device Package	Device Marking
NCE30TD60BD	TO-263	NCE30TD60BD



TO-263

Absolute Maximum Ratings (T_C=25°C unless otherwise noted)

Symbol	Parameter	Value	Units
Vces	Collector-Emitter Voltage	600	V
V _{GES}	Gate- Emitter Voltage	±30	V
	Collector Current	60	А
lc	Collector Current @T _C = 100°C	30	А
I _{Cplus}	Pulsed Collector Current, tp limited by T _{jmax}	90	А
-	turn off safe operating area, V _{CE} =600V, Tj=150°C	90	А
I _F	Diode Continuous Forward Current @T _C = 100°C	30	А
I _{FM}	Diode Maximum Forward Current	90	А
Б	Power Dissipation @ T _C = 25°C	190	W
P _D	Power Dissipation @T _C = 100 °C	76	W
T _J ,T _{stg}	Operating Junction and Storage Temperature Range	-55 to +150	°C
TL	Maximum Temperature for Soldering	260	°C
t _{sc}	Short circuit withstand time V _{GE} =15V, V _{CC} ≤400V, Allowed number of short circuits<1000Time between short circuits:≥1.0s,T _j ≤150°C	3	us



NCE30TD60BD

Thermal Characteristic

Symbol	Parameter	Value	Units
Rejc	Thermal Resistance, Junction to case for IGBT	0.65	°C/W
R _θ JC	Thermal Resistance, Junction to case for Diode	1.08	°C/W
RθJA	Thermal Resistance, Junction to Ambient	40	°C/W

Electrical Characteristics (Tc=25°C unless otherwise noted)

0		Test Conditions		Value			
Symbol	Parameter			Min.	Тур.	Max.	Units
Static Chara	cteristics					'	
V _{(BR)CES}	Collector-Emitter Breakdown Voltage	V _{GE} =0V	,I _{CE} =1mA	600			V
Ices	Collector-Emitter Leakage Current	V _{GE} =0V	V _{CE} =600V			4	uA
I _{GES(F)}	Gate to Emitter Forward Leakage	V _{GE} =+30	V,Vce=0V			200	nA
I _{GES(R)}	Gate to Source Reverse Leakage	V _{GE} =-30	V,Vce =0V			200	nA
	0.11 . 5 0	Ic=30A	Tj=25°C		1.7	1.9	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$V_{\text{GE}}=15V$	Tj=150°C		1.9		V
$V_{GE(th)}$	Gate Threshold Voltage	Ic=1mA,VcE=VgE		4.0	5.0	6.0	V
Dynamic Cha	aracteristics				•		
Cies	Input Capacitance	V _{CE} =25V,V _{GE} =0V, f=1MHz			3552		pF
Coes	Output Capacitance				106		
C _{res}	Reverse Transfer Capacitance				67		
Q_g	Total Gate Charge	Vcc=480V, Ic=30A VgE=15V			132		nC
Qge	Gate to Emitter Charge				28		
Qgc	Gate to Collector Charge				54		
I _{C(SC)}	Short circuit collector current Max.1000 short circuits Time between short circuits: ≥1.0s	V _{GE} =15V,V _{CC} ≤400V, t _{SC} ≤3us,Tj≤150°C			190		А
Switching Cl	naracteristics						
$t_{\text{d}(\text{ON})}$	Turn-on Delay Time				19		
t _r	Rise Time				17		20
t _{d(OFF)}	Turn-Off Delay Time	Vcc=400V,Ic=30A			166		ns
t _f	Fall Time	$V_{GE}=0/15V$, $R_g=5\Omega$			16		
Eon	Turn-On Switching Loss	Inductive Load			0.36		
E _{off}	Turn-Off Switching Loss				0.32		mJ
Ets	Total Switching Loss				0.68		

Electrical Characteristics of the Diode (T_C= 25°C unless otherwise specified):

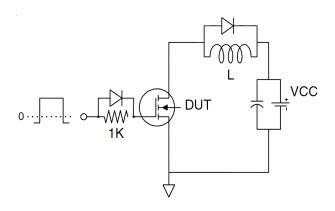
Cumbal	Parameter	Took Conditions	Rating			l linita
Symbol		Test Conditions	Min.	Тур.	Max.	Units
V _{FM}	Diode Forward Voltage	I _F =30A		1.7	1.9	V
Trr	Reverse Recovery Time			178		ns
I _{RRM}	Diode Peak Reverse Recovery Current	I _F =30A, di/dt=200A/us		4		А
Qrr	Reverse Recovery Charge			0.4		uC
Pulse width $t_{tp} \le 380 \mu s, \delta \le 2\%$						



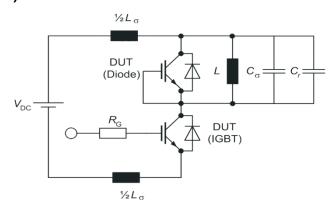


Test Circuit

1) Gate Charge Test Circuit

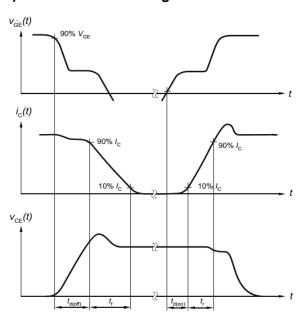


2) Switch Time Test Circuit

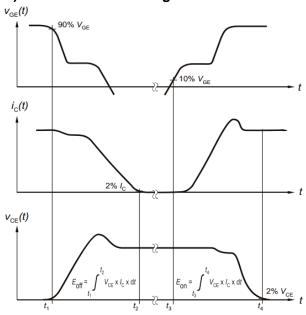


Switching characteristics

1) definition of switching times

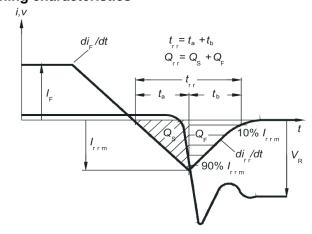


2) definition of switching losses



3) Definition of diode switching characteristics

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Typical Electrical and Thermal Characteristics

Figure 1 Output Characteristics

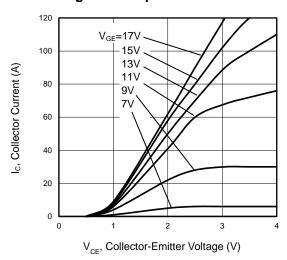


Figure 3 V_{CEsat} vs. Case Temperature

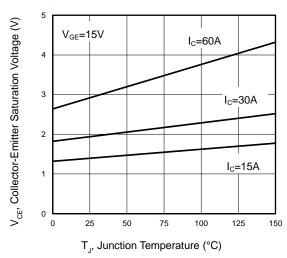


Figure 5 Capacitance Characteristics

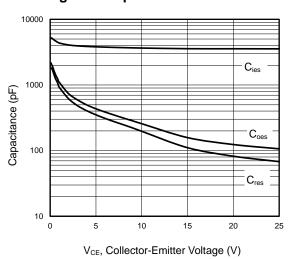


Figure 2 Transfer Characteristics

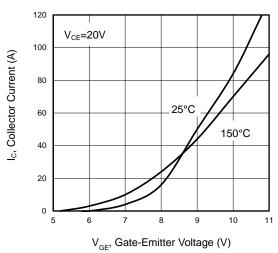


Figure 4 Saturation Voltage vs. V_{GE}

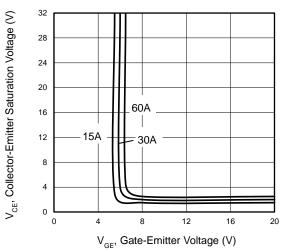
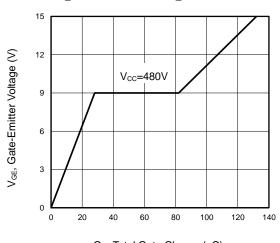


Figure 6 Gate charge waveform



Q_G, Total Gate Charge (nC)



Typical Electrical and Thermal Characteristics

Figure 7 Gate-emitter Threshold Voltage as a Function of Junction Temperature

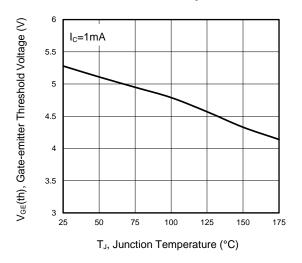


Figure 9 Typical Switching Times as a Function of Gate Resistor

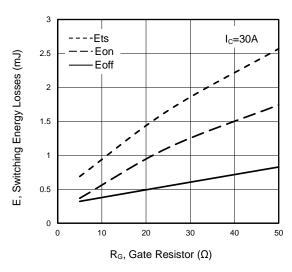


Figure 11 Typical Collector-emitter Saturation
Voltage as a function of Collector Current

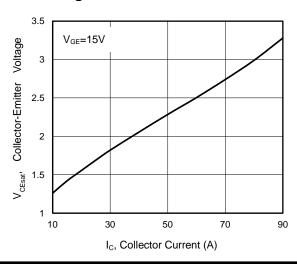
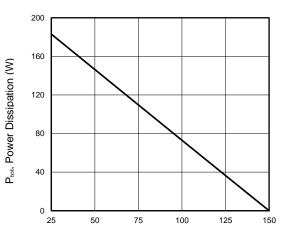


Figure 8 Power Dissipation as a Function of Case Temperature



T_C, Case Temperature (°C)

Figure 10 Typical Switching Times as a Function of Junction Temperature

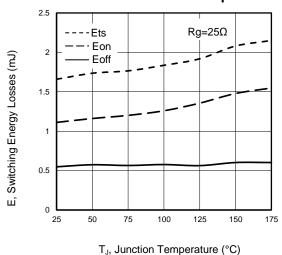
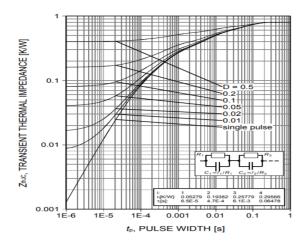
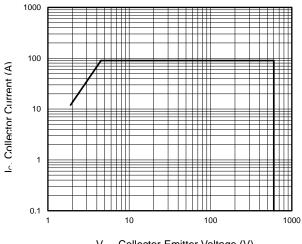


Figure 12 Transient Thermal Impedance



Typical Electrical and Thermal Characteristics

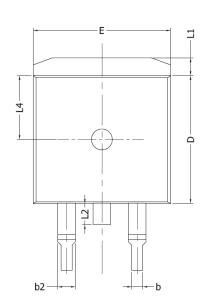
Figure 13 Forward Bias Safe Operating Area

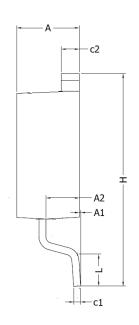


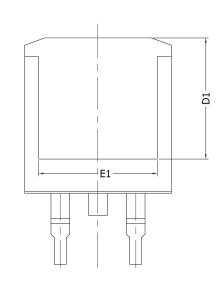
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TO-263-3L Package Information







Symbol	Dimensions In Millimeters		Dimensions In Inches		
- Cymbol	Min.	Max.	Min.	Max.	
А	4.40	4.60	0.17	0.18	
A1	0.00	0.25	0.00	0.01	
A2	2.20	2.60	0.09	0.10	
b	0.76	0.89	0.03	0.04	
b2	1.23	1.37	0.05	0.05	
С	0.47	0.60	0.02	0.02	
c1	0.46	0.56	0.02	0.02	
c2	1.25	1.35	0.05	0.05	
D	0.91	0.93	0.04	0.04	
D1	8.00	-	0.31	-	
Е	9.80	10.00	0.39	0.39	
E1	7.80	-	0.31	-	
е	2.5	2.54BSC		BSC	
Н	14.90	15.70	0.59	0.62	
L	2.00	2.60	0.08	0.10	
L1	1.17	1.40	0.05	0.06	
L2	-	1.75	-	0.07	
L4	4.6	0REF	0.18REF		



NCE30TD60BD

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 APT36GA60BD15
 APT40GP60B2DQ2G
 APT40GP90B2DQ2G
 APT50GN120B2G
 APT50GT60BRG

 APT64GA90B2D30
 APT70GR120J
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 APT30GN60BG
 APT30GS60BRDQ2G
 APT30N60BC6
 APT35GP120JDQ2
 APT36GA60B
 APT45GR65B2DU30

 APT50GP60B2DQ2G
 APT68GA60B
 APT70GR65B
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